

TN9926BNPA

Dual N-Channel Enhancement Mode Power MOSFET

Product Summary

- V_{DS}= 20V,I_D= 6A
- $R_{DS(on)}$ < 25m Ω @ V_{GS} = 4.5V
- $R_{DS(on)} < 35m\Omega @V_{GS} = 2.5V$

Features

- Advanced Trench Technology
- RoHS and Reach Compliant
- Halogen and Antimony Free
- Moisture Sensitivity Level 3

Application

- Power Switching Application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

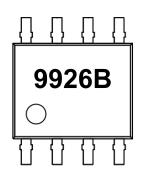
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SOP-8

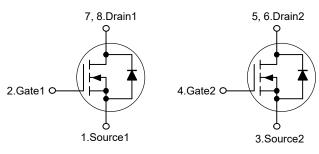
(Top View)

Pin	Description	Pin	Description
1	Source1	4	Gate2
2	Gate1	5,6	Drain2
3	Source2	7,8	Drain1

Marking Code



Schematic Diagram



N-Channel

N-Channel

Absolute Maximum Ratings

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	±12	V
Drain Current-Continuous	I _D	6	Α
Drain Current-Pulsed Note1	I _{DM}	26	Α
Maximum Power Dissipation	P _D	2.0	W
Junction Temperature	TJ	150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Thermal Characteristics

Thermal Resistance,Junction-to-Ambient Note2	R _{θJA}	62.5	°C/W
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Electrical Characteristics

(T_J=25°C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	20	-	-	V
Rds(on)	Static Drain-Source On- Resistance ²	V _{GS} =4.5V, I _D =6A	-	21	25	mΩ
		Vgs=2.5V, ID=4A	-	32	35	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	-	1.2	3	V
g fs	Forward Transconductance	V _{DS} =10V, I _D =6A	-	6	-	s
IDSS	Drain-Source Leakage Current	V _{DS} =20V, V _{GS} =0V	-	-	25	uA
	Drain-Source Leakage Current (Tj=70°C)	V _{DS} =20V ,V _{GS} =0V	-	-	250	uA
lgss	Gate-Source Leakage	V _{GS} = <u>+</u> 12V, V _{DS} =0V	-	-	<u>+</u> 100	nA
Qg	Total Gate Charge ²	ID=6A	-	11	17.6	nC
Qgs	Gate-Source Charge	V _{DS} =16V V _{GS} =4.5V	-	1.1	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge		-	4.1	-	nC
t _{d(on)}	Turn-on Delay Time ²	V _{DS} =10V	-	4.2	-	ns
t _r	Rise Time	I_D =1A R_G =3.3 Ω , V_{GS} =10V R_D =10 Ω	-	9	-	ns
t _{d(off)}	Turn-off Delay Time		-	23	-	ns
tf	Fall Time		-	3.5	-	ns
Ciss	Input Capacitance	V _{GS} =0V	-	570	910	pF
Coss	Output Capacitance		-	90	-	pF
Crss	Reverse Transfer Capacitance	V _{DS} =20V f=1.0MHz	-	85	-	pF
Rg	Gate Resistance	f=1.0MHz	-	1.6	2.4	Ω
V _{SD}	Forward On Voltage ²	I _S =1.7A, V _{GS} =0V	-	-	1.2	V
trr	Reverse Recovery Time ²	Is=6A, V _{GS} =0V,	-	21	-	ns
Qrr	Reverse Recovery Charge	dl/dt=100A/µs	-	14	-	nC

Notes:

- 1. Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in 2 copper pad of FR4 board, t \leq 10sec ; 135 °C/W when mounted on Min. copper pad.

Typical Characteristic Curves

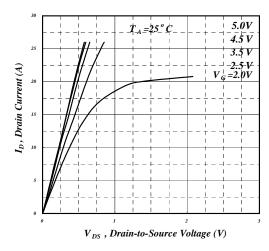


Fig 1. Typical Output Characteristics

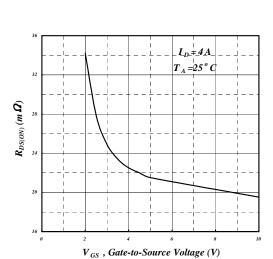


Fig 3. On-Resistance v.s. Gate Voltage

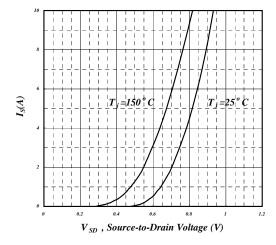


Fig 5. Forward Characteristic of Reverse Diode

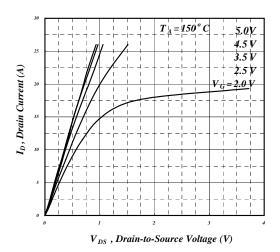


Fig 2. Typical Output Characteristics

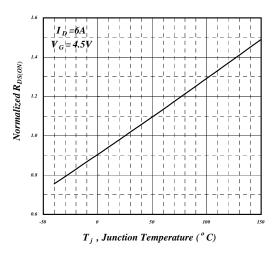


Fig 4. Normalized On-Resistance v.s. Temperature

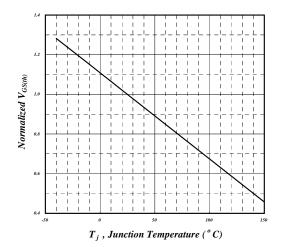


Fig 6. Gate Threshold Voltage v.s.
Junction Temperature

Typical Characteristic Curves

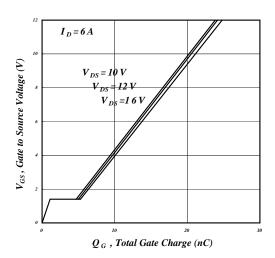


Fig 7. Gate Charge Characteristics

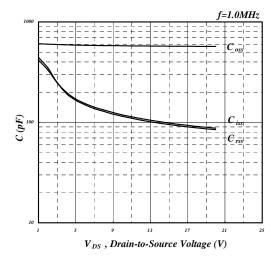


Fig 8. Typical Capacitance Characteristics

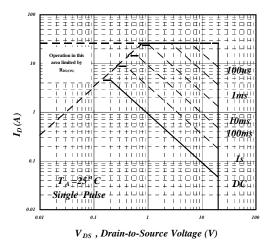


Fig 9. Maximum Safe Operating Area

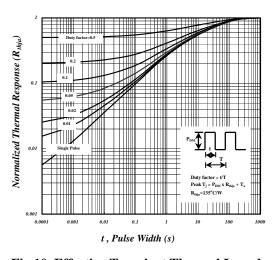


Fig 10. Effective Transient Thermal Impedance

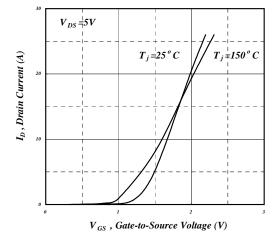


Fig 11. Transfer Characteristics

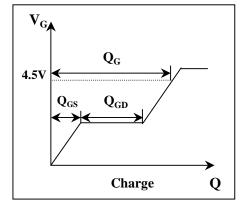
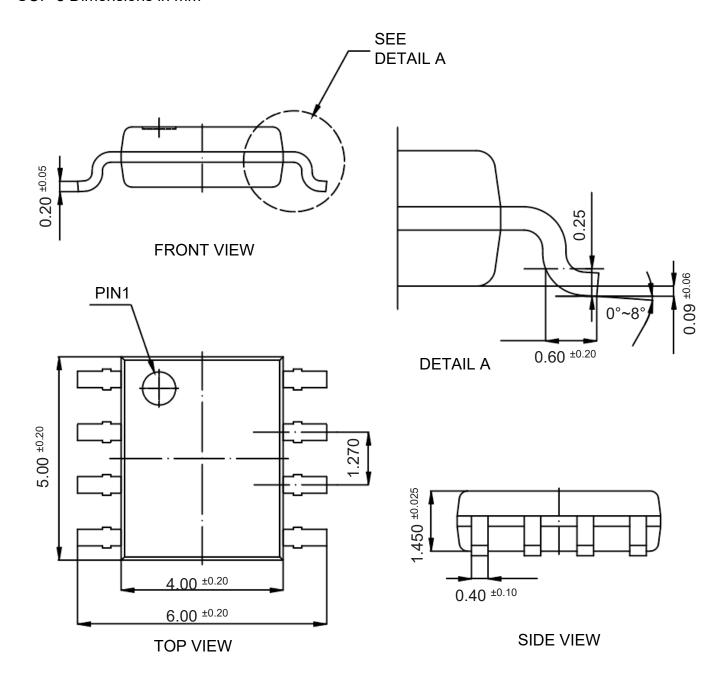


Fig 12. Gate Charge Waveform

Package Outline

SOP-8 Dimensions in mm



Ordering Information

Device	Package	Shipping
TN9926BNPA	SOP-8	4,000PCS/Reel&13inches

Contact Information

For additional information, please contact your local Sales Representative.



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